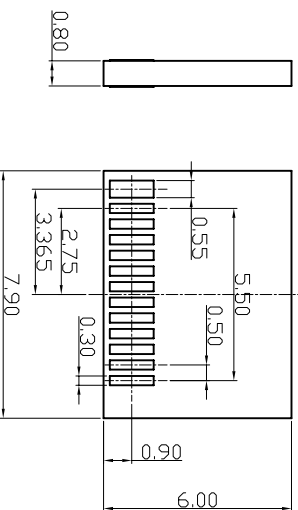
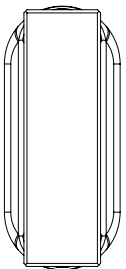
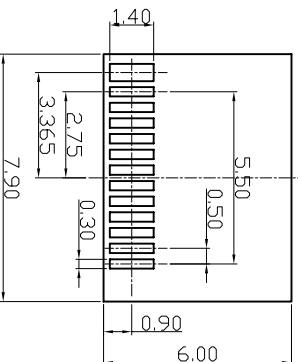
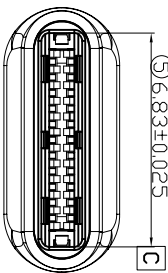
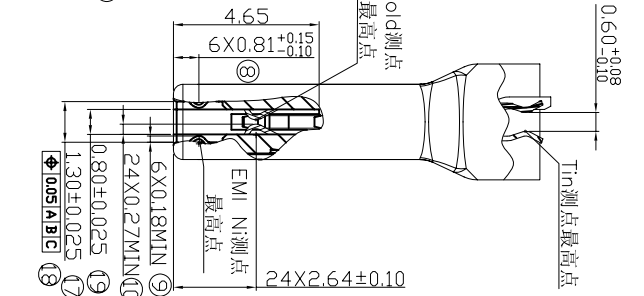
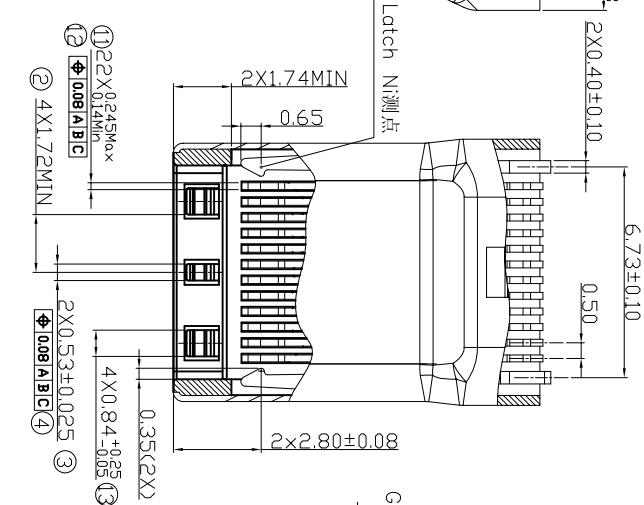
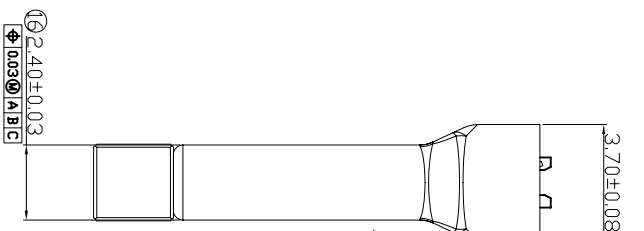
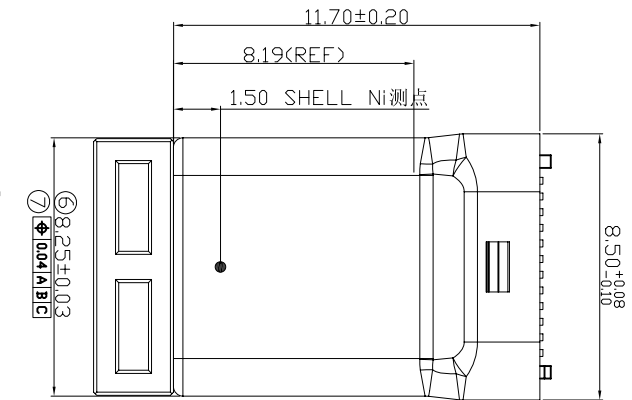
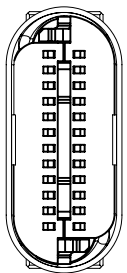


REV	DESCRIPTION	ECN NO.	DATE
AA	原始图档		2015.12.05



RECOMMEND PCB LAYOUT  
PCB TOLERANCE:±0.05

7	SHRAPNEL	SUS	2	Min. Ni 75u"	301
6	LATCH	SUS	1	Min. Ni 75u"	301
5	CONTACT	PHOSPHOR BRONZE	24	Underplate:Min.Ni75u". Mating grea:Min.Au SELECTION Solder Tails:Min 80u". bright tin	/
4	SHELL	SUS	1	Min. Ni 80u"	S316L
3	COVRE	LCP GF30%	1	UL94V-0	BLACK
2	HOUSING	LCP GF30%	1	UL94V-0	BLACK/WHITE
1	MD HOUSING	LCP GF30%	2	UL94V-0	BLACK
NO.	NAME	MATERIAL	QTY	STANDARD	NOTE

GENERAL TOLERANCES (UNLESS SPECIFIED)		SCALE: 1:1	NUMBER: 11
MM		DESIGN BY DATE	李玉兰 2015.12.05
X	±0.38	DRAWN BY DATE	李玉兰 2015.12.05
.XX	±0.25	CHECKED BY DATE	
.XXX	±0.13	ANGULAR ±3°	

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	APPROVED BY DATE	PART NO.	DWG NO.	SHEET NO.
		USB24F-136XXX-X-XX	Ub-136-0	1/1

NAME: USB3.1 TYPE-C 24PIN 线端夹板式(3.7铁壳)		THIRD ANGLE PROJECTION	REVISE ON CAD ONLY
---	--	------------------------	--------------------

深圳市瀚云通科技有限公司  
SHENZHEN HANYUNTONG TECHNOLOGY LIMITED

Ordering Information:  
 UB24F-136 X X X - X - XX  
 Housing Material: A: LCP White K:BLACK  
 Housing Color: PLATING TYPE: B:GOLD/TIN  
 PLATING THICKNESS: 5-15 μ" 6-30 μ"  
 Picking: 1:1roy

1.Electrical Performance:  
 Current Rating:5A on Vbus / 1.25A on Vcom/0.25A on others  
 Insulation Resistance:100MΩ MIN;  
 Dielectric Voltage:100 VAC/minute;  
 Contact Resistance:40mΩ Max for Initial;  
 2.Mechanical Performance:  
 Insertion Force:5~20N  
 Extraction Force:8~20N  
 Durability:10,000 Times  
 3.SS pairs Impedance: Mated area:85+/-90;  
 焊盘区:800-960;  
 Rise time:40ps;  
 USB 2.0 pair Impedance: Mated area:90+/-15%;  
 Rise time:200ps.